

Contents lists available at [ScienceDirect](http://www.sciencedirect.com/science/journal/09258388)

Journal of Alloys and Compounds

journal homepage: www.elsevier.com/locate/jalcom

Letter

Large-area synthesis of high-quality and uniform monolayer graphene without unexpected bilayer regions

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article info

Article history: Received 19 March 2014 Received in revised form 11 June 2014 Accepted 1 July 2014 Available online 9 July 2014

Keywords: Semiconductors Vapor deposition Catalysis Diffusion Electronic properties

ABSTRACT

Chemical vapor deposition is a promising method to synthesize the large area monolayer graphene. However, unexpected bilayer regions are easily formed on the monolayer graphene, which will dramatically degrade the quality and uniformity of graphene. In this work, the large-area, high-quality and uniform monolayer graphene has been synthesized on the Cu foil. The studies reveal that the density of bilayer graphene regions decreases with increasing the growth time; when the growth time increases to 120 min, the formation of bilayer regions is effectively prevented. The corresponding growth mechanism was discussed. Further, the electrical studies reveal that by preventing the formation of bilayer regions, the mobility of graphene not only obviously increases, but also has a narrow distribution, indicating that the as-synthesized monolayer graphene has high quality and uniformity. We expect that this work is beneficial for not only potential applications, but also the fundamental understanding of the growth mechanism for graphene on Cu surface.

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1. Introduction

Graphene, a one-atom-thick planar sheet of $sp²$ -hybridized carbon, has drawn much attention due to the outstanding properties and wide potential applications $[1-3]$. For practical applications, it is significant to achieve the large-area synthesis of monolayer graphene with high quality and uniformity. Recently, chemical vapor deposition (CVD) is considered as one of the most promising methods to synthesize large-area monolayer graphene film [\[4\].](#page--1-0) However, unexpected multilayer or bilayer regions are usually observed on the CVD monolayer graphene, which obviously influence the quality and uniformity of graphene [\[5,6\]](#page--1-0).

Until now, there are many efforts to investigate the growth mechanism of CVD graphene films grown on Cu foils [\[6–8\]](#page--1-0). Liu et al. [\[6\]](#page--1-0) demonstrated that the multilayer or bilayer regions were formed on the imperfection sites of Cu substrates with high chemical activation energy, and low pressure annealing in H_2 (before graphene growth) could make the Cu surface smoother and thereby prevent the formation of multilayer regions; however, some bilayer regions were still formed on the monolayer graphene. Herein, we report an effective way to synthesize the high-quality and uniform CVD monolayer graphene without bilayer regions. Optical microscope (OM), scanning electron microscope (SEM), Raman spectroscopy and electrical measurements were used to investigate the growth mechanism and evaluate the quality and uniformity of graphene.

2. Experimental

2.1. CVD synthesis of graphene

Firstly, the Cu foil was dipped into the dilute HCI/H_2O (1:10) solution for 3 min, and then washed by deionization (DI) water several times to remove the residual acid solution, and then was dried by nitrogen gas. Secondly, the Cu foil was loaded into the silica tube of the CVD system with a vacuum background of 7×10^{-4} Pa, and then the growth chamber was heated to 1000 $^{\circ}$ C and held for 20 min with 30 sccm pure H₂ (99.999%), and then the 15 sccm of CH₄ was introduced into the tube for graphene growth at 1000 °C for 20-180 min with the pressure of 340 Pa. Finally, cooled the system to room temperature with a cooling rate of 50 $°C/min$ in CH4/H2 ambience. The as-synthesized graphene samples were denoted as G-X, where X represents the growth time (min).

2.2. Transfer process of graphene films

Firstly, the surface of graphene grown on the Cu foil was spin-coated with poly(methyl methacrylate) solution (PMMA, A4) at 3000 rpm for 30 s, and then the Cu foil was etched away in the iron trichloride solution (FeCl₃, 1 mol/L) for

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Fig. 1. SEM images of G-20 grown on the Cu foil (a) without and (b) with dilute HCl pretreatment. (c) OM image of G-20 transferred onto the SiO₂/Si substrate. (d) Raman spectra of the red and black circle regions in the (c). (For interpretation of the references to color in this figure legend, the reader is referred to the web version of this article.)

Fig. 2. (a) Schematic diagram of graphene grown on the Cu foil. (b-d) OM images of G-20, G-80, G-120 and G-180 transferred onto the SiO₂/Si substrates.

12 h. Secondly, after the PMMA/graphene film was rinsed repeatedly using the DI water (10 times), it was transferred to the $H_2O/HCl/H_2O_2$ (20:1:1) solution for 15 min for removing the residual metal particles, and then was transferred to the $H_2O/NH_4OH/H_2O_2$ (20:1:1) solution for 15 min for removing the insoluble organic contaminants. Note that the PMMA/graphene film was rinsed using the DI water to remove the residual solution after each cleaning step. Thirdly, the PMMA/ graphene was transferred onto the target substrate $(SiO₂/Si$ or PET substrates), and then was baked at 150 °C for 10 min after natural drying, and then the PMMA was removed using acetone [\[9\]](#page--1-0).

The graphene field-effect transistors (FETs) were fabricated by using standard photolithography after transferring the graphene onto the 270 nm $SiO₂/Si$ substrate. The Ni (30 nm) film was deposited as source and drain electrodes; the 270 nm $SiO₂$ and n++ silicon layers acted as the gate dielectric and back-gate electrode, respectively. The electrical measurements were carried out with an Agilent 4155B semiconductor parameter analyzer in air at room temperature.

3. Results and discussions

2.3. OM, SEM, Raman and electrical measurements

The surface morphology and structure of graphene were studied by using OM (Olympus BX51M), SEM (JSM-6490LV) and Raman spectrometer (Renishaw, 514 nm) at room temperature.

Before graphene growth, it is necessary to use dilute HCl to remove the native Cu-oxide layer on the Cu foil, otherwise the Cu-oxide nanoparticles will be formed on the graphene, as shown in Fig. 1a. Fig. 1b shows the SEM image of G-20 grown on the Cu foil with dilute HCl pretreatment. Although the graphene surface

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